

FEATURES

- * HIGH DENSITY SOCKETS FOR IC WITH A PITCH OF 1.778 MM
- * LOW PROFILE DESIGN.
- * SAVING ON PCB REAL SETATE.
- * MANUALLY AND AUTOMATICALLY INSERTABLE.
- * CLOSCED BOTTOM DESIGN TO PREVENT SOLDER WICKING.
- * PROVIDED NEW TYPE FOR FLUX PROTECTION.

TECHNICAL DATA

MATERIAL

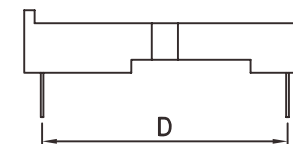
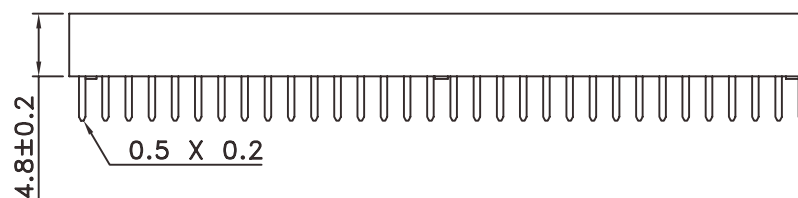
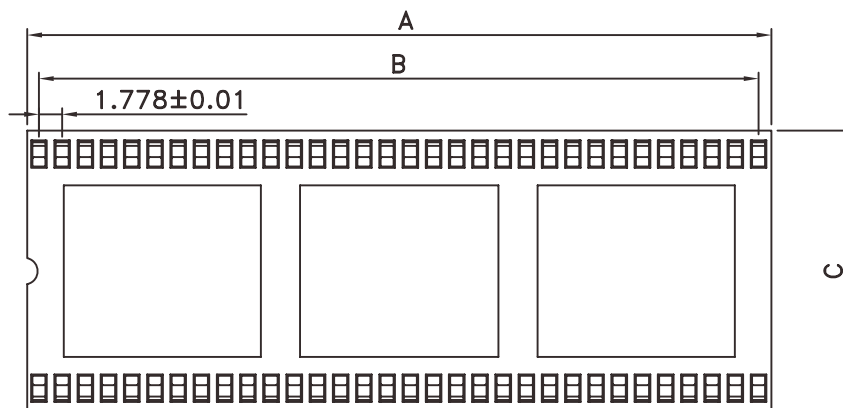
- * CONTACT:PHOSPHOR BRONZE.
- * PLATING:TIN PLATED.
- * INSULATOR:GLASS FILLED POLYESTER P.B.T. (UL-94 V-0)

MACHANICAL

- * OPERATING TEMPERATURES:-55°C~+125°C.
- * INSERTION FORCE: 450 G
- * WITHDRAWAL FORCE: 70 G MIN

ELECTRICAL

- * CURRECT RATING: 1 AMP. MAX.
- * CONTACT RESISTANCE: 20M OMH MIN.
- * WITHSTANDING VOLTAGE: AC 600V/MINUTE.



POSITION	A	B	C	D	SPACE
40	35.56	33.78	17.70	15.24	06
42	37.34	35.56	17.70	15.24	
48	42.67	40.89	17.70	15.24	
52	46.23	44.45	17.70	15.24	
54	48.01	46.23	17.70	15.24	
56	49.78	48.01	17.70	15.24	
64	56.90	55.12	17.70	15.24	

RoHS Compliant

TOLERANCES ARE

MORETHANALL
PCB CONNECTORS
Cable ASSEMBLIES

煜倫股份有限公司

www.morethanall.com

DRAWING BY CY

CHECKED BY GENIUS

UNIT / mm

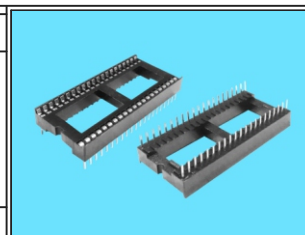
SCALE 1 : 1

DATE

SIZE A4

PPOJECTION

X. ±
.X ±
.XX ±
.XXX ±
ANG ±



ORDER INFORMATION

HIC-D06-xx-LF
SERIES | LEADFREE
40~64WAY
SPACING 15.24mm
DIP 180°

DESCRIPTION: HIGH DESITY 1.778MM IC SOCKET